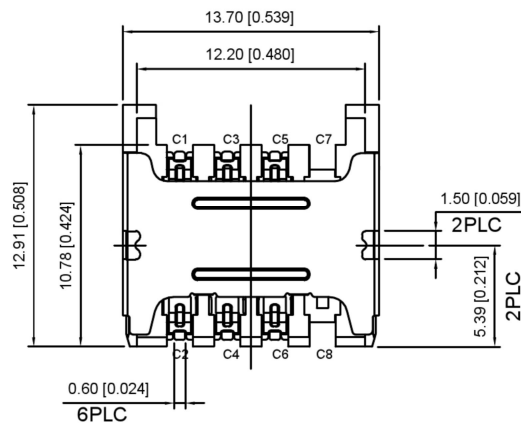
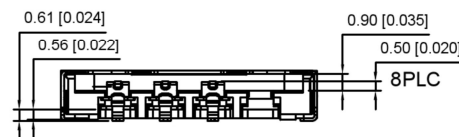
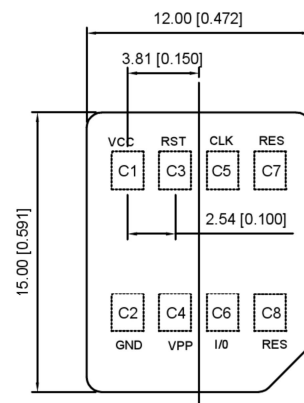


INSERT CARD



MICRO SIM CARD	
PIN NO.	DESCRIPTION
C1	VCC
C3	RST
C5	CLK
C7	
C2	GND
C4	VPP
C6	I/O
C8	



MICRO SIM CARD
芯片面朝下视图

NOTES:

1)MATERIAL:

HOUSING 胶壳:LCP UL 94V-0

CONTACT 端子:C5210R-H

SHELL 外壳:SUS201-H

2)FINISH 电镀:

CONTACT 端子:GOLD FLASH PLATED ON CONTACT AREA:
GOLD FLASH PLATING ON SOLDER TAILS,
WITH ENTIRE CONTACT UNDERPLATED NICKEL

SHELL 外壳: NICKEL UNDERPLATED OVERALL.
GOLD FLASH PLATED ON SOLDER TAILS

3)ELECTRICAL CHARACTERISTICS 电气特性

RATING CURRENT 额定电流: 0.5A MAX.

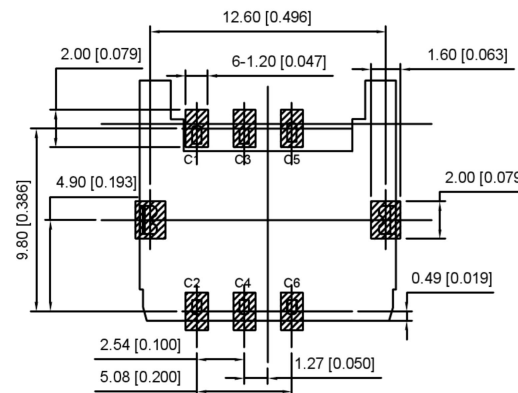
CONTACT RESISTANCE 接触电阻:50 mΩ MAX

DIELECTRIC WITHSTANDING 耐电介质: 50OV AC MIN.

INSULATION RESISTANCE 绝缘电阻:1000 MΩ MIN.

4)MECHANICAL CHARACTERISTICS 机械特性

MATING CYCLE 拔插周期:3000 CYCLES



RECOMMENDED PCB LAYOUT(TOP VIEW)
GENERAL TOLERANCES:±0.05

				ANGLAR	±5°
				L≤ 4	±0.2
				4<L≤ 16	±0.3
				16<L≤ 63	±0.4
				L> 63	±0.5
REVISIONS				UNSPECIFIED TOLERANCES	
	DATE	REVISED	APPROVED		
www.alpsr.com www.gdxjdz.com www.xbswitch.com					



DONG GUAN XI BANG ELECTRONIC CO., LTD

DSND		SCALE: N/A	MODEL TYPE: SIM CARD CONN
DWN		VIEW:	PART NO.: XKSIM-2651-P6
CHKD		UNIT: mm/in	DWG NO.:
APPD		SIZE: A4	
			WEIGHT
			SHEET
			REVISION
			1/1
			A0